QSFPDD-400G-FR4-XXW

400GBase QSFP-DD CWDM4 2km Reach



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Features

- QSFP DD MSA compliant
- 400G FR4 specification compliant
- Non hermetic package design
- 4 CWDM lanes MUX/DEMUX design
- 8x 26.5625 GBd PAM4 electrical interface (400GAUI 8)
- Power dissipation 12W (0~70°C)
- LC duplex connector
- Supports 425 Gbit/s aggregate bit rate
- Up to 2 km transmission on single mode fiber with FEC
- Single 3.3 V power supply
- RoHS 2 compliant



Applications

Data center interconnect

Part number	Product description
QSFPDD-400G-FR4-XXW	400GBase SMF QSFP-DD CWDM4 2km 0°C to 70°C LC Duplex DDM (12W)

PIN Description

Pin		Function/Description	Notes
1	GND	Transmitter Ground (Common with Receiver Ground)	1
2	Tx2-	Transmitter Inverted Data Input	
3	Tx2+	Transmitter Non-Inverted Data output	
4	GND	Transmitter Ground (Common with Receiver Ground)	1
5	Tx4-	TransmitterInverted Data Input	
6	Tx4+	Transmitter Non-Inverted Data output	
7	GND	Transmitter Ground (Common with Receiver Ground)	1
8	ModSelL	Module Select	
9	ResetL	Module Reset	
10	VccRx	3.3V Power Supply Receiver	2
11	SCL	2-Wire serial Interface Clock	
12	SDA	2-Wire serial Interface Data	
13	GND	Transmitter Ground (Common with Receiver Ground)	1
14	Rx3+	Receiver Non-Inverted Data Output	
15	Rx3-	Receiver Inverted Data Output	
16	GND	Transmitter Ground (Common with Receiver Ground)	1
17	Rx1 +	Receiver Non-Inverted Data Output	
18	Rx1 -	Receiver Inverted Data Output	
19	GND	Transmitter Ground (C ommon with Receiver Ground)	1
20	GND	Transmitter Ground (Common with Receiver Ground)	1
21	Rx2-	Receiver Inverted Data Output	
22	Rx2+	Receiver Non-Inverted Data Output	
23	GND	Transmitter Ground (Common with Receiver Ground)	1
24	Rx4-	Receiver Inverted Data Output	
25	Rx4+	Receiver Non-Inverted Data Output	
26	GND	Transmitter Ground (Common with Receiver Ground)	1
27	ModPrsl	Module Present	
28	IntL	Interrupt	
29	VccTx	3.3V power supply transmitter	2
30	Vcc1	3.3V power supply	2
31	LPMode	Low Power Mode	
32	GND	Transmitter Ground (Common with Receiver Ground)	1
33	Tx3+	Transmitter Non-Inverted Data Input	
34	Tx3-	Transmitter Inverted Data Output	
35	GND	Transmitter Ground (Common with Receiver Ground)	1
36	Tx1 +	Transmitter Non-Inverted Data Input	
37	Tx1 -	Transmitter Inverted Data Output	
38	GND	Transmitter Ground (Common with Receiver Ground)	1

Pin		Function/Description	Notes
39	GND	Transmitter Ground (Common with Receiver Ground)	1
40	Tx6-	Transmitter Inverted Data Input	
41	Tx6+	Transmitter Non-Inverted Data output	
42	GND	Transmitter Ground (Common with Receiver Ground)	1
43	Tx8-	TransmitterInverted Data Input	
44	Tx8+	Transmitter Non-Inverted Data output	
45	GND	Transmitter Ground (Common with Receiver Ground)	1
46	Reserved	For future use	3
47	VS1	Module Vendor Specific	3
48	VccRx1	3.3V Power Supply Receiver	2
49	VS2	Module Vendor Specific 2	3
50	VS3	Module Vendor Specific 3	3
51	GND	Transmitter Ground (Common with Receiver Ground)	1
52	Rx7+	Receiver Non-Inverted Data Output	
53	Rx7-	Receiver Inverted Data Output	
54	GND	Transmitter Ground (Common with Receiver Ground)	1
55	Rx5+	Receiver Non-Inverted Data Output	
56	Rx5-	Receiver Inverted Data Output	
57	GND	Transmitter Ground (C ommon with Receiver Ground)	1
58	GND	Transmitter Ground (Common with Receiver Ground)	1
59	Rx6-	Receiver Inverted Data Output	
60	Rx6+	Receiver Non-Inverted Data Output	
61	GND	Transmitter Ground (Common with Receiver Ground)	1
62	Rx8-	Receiver Inverted Data Output	
63	Rx8+	Receiver Non-Inverted Data Output	
64	GND	Transmitter Ground (Common with Receiver Ground)	1
65	NC	No Connect	
66	Reserved	For future use	
67	VccTx1	3.3V power supply transmitter	2
68	Vcc2	3.3V power supply	2
69	Reserved	For future use	3
70	GND	Transmitter Ground (Common with Receiver Ground)	1
71	Tx7+	Transmitter Non-Inverted Data Input	
72	Tx7-	Transmitter Inverted Data Output	
73	GND	Transmitter Ground (Common with Receiver Ground)	1
74	Tx5+	Transmitter Non-Inverted Data Input	
75	Tx5-	Transmitter Inverted Data Output	
76	GND	Transmitter Ground (Common with Receiver Ground)	1

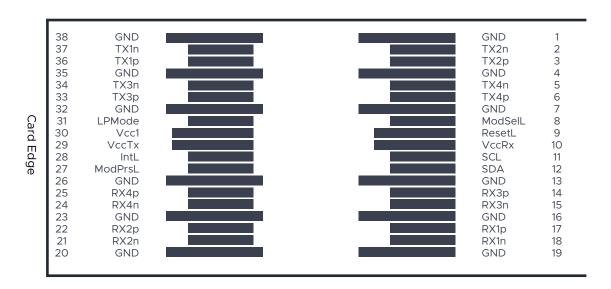
Notes:

- 1. QSFP-DD uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.
- 2. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 shall be applied concurrently. Requirements defined for the host side of the Host Card Edge Connector are listed in the table. VccRx, VccRx1, Vcc1, Vcc2, VccTx and VccTx1 may be internally connected within the module in any combination. The connector Vcc pins are each rated for a maximum current of 1000 mA.
- 3. All Vendor Specific, Reserved and No Connect pins may be terminated with 50 Ω to ground on the host. Pad 65 (No Connect) shall be left unconnected within the module. Vendor specific and Reserved pads shall have an impedance to GND that is greater than 10 k Ω and less than 100 pF.
- 4. Plug Sequence specifies the mating sequence of the host connector and module.

Pin Assignment and Description



Top Side Viewed from Top



Bottom Side Viewed from Bottom

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units	Notes
Storage Temperature	Ts	-40	85	°C	
Power Supply Voltage	Vcc	-0.5	3.6	V	
Relative Humidity (non-condensation)	RH	5	95	%	

Notes:

Exceeding any of these values may be harmful for the device

Recommend Operation Conditions

Parameter	Min	Тур	Max	Unit	Notes
Power Supply Voltage	3.13	3.3	3.47	V	-
Power Supply Current (com.)	-	-	3630	mA	-
Case Operating Temperature (com.)	0	-	+70	°C	-

Electrical Characteristics

Parameter	Min	Тур	Max	Unit	Notes
Transmitter					
Differential input Voltage pk-pk	900	-	-	mV	1
Common Mode Voltage	-350	700	2850	mV	2
Single-ended Voltage Tolerance Range	-0.4		3.3	V	-
Differential Input Return Loss	IEEE 802.	3-2015 Equatio	on (83E-5)	dB	-
Differential to Common Mode Input Return Loss	IEEE 802.	3-2015 Equatio	on (83E-6)	dB	-
Module Stressed Input Test	-	IEEE 802.3cu	-	-	3
Receiver					
Differential output Voltage pk-pk	-	-	900	mV	-
Common Mode Voltage	-350	-	2850	mV	2
Common Mode Noise, RMS	-	-	17.5	mV	-
Transition time	9.5	-	-	ps	4
Near-end Eye height, differential	70	-	-	mV	-
Near-end ESMW (Eye symmetry mask width)	-	0.265	-	UI	-
Far-end ESMW (Eye symmetry mask width)	-	0.2	-	UI	-
Far-end Eye height, differential	30	-	-	mV	-
Far-end pre-cursor ISI ratio	-4.5	-	2.5	%	-
Differential output return loss	IEEE 802.	3-2015 Equation	on (83E-2)		-
Common to differential mode conversion return loss	IEEE 802.	3-2015 Equation	on (83E-3)		-

Notes:

- 1. With the exception to IEEE 802.3bs 120E.3.1.2 that the pattern is PRBS31Q or scrambled idle
- 2. DC common mode voltage generated by the host. Specification includes effects of ground offset voltage.
- 3. BER specified in IEEE 802.3bs 120E.1.1.
- 4. 20% ~ 80%

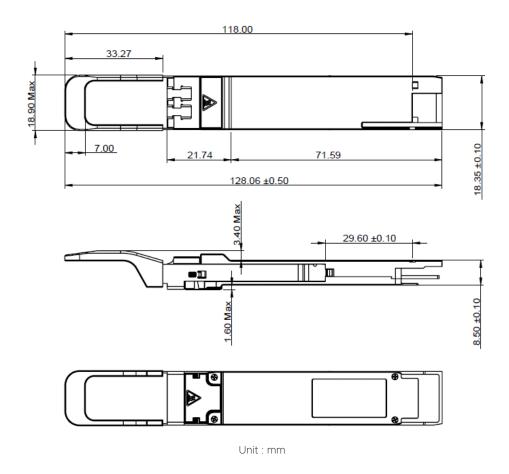
Transceiver Optical Characteristics

Parameter		Min	Typical	Max	Units	Notes
Transmitter						
Average Launch Power each Lane		-3.3	-	3.5	dBm	1
Total Launch Optical Power		-	-	9.5	dBm	-
Launched Outer OMA(OMA oute	r), each Lane	-1.3	-	4.5	dBm	2
Difference in Launch Power betw Lanes (OMA outer)	veen any two	-	-	4.0	dB	2
Launched Outer OMA minus TDE	ECQ, each Lane	-1.6	-	-	dB	3
	l LO	1264.50	1271.00	1277.50	nm	-
Cooley Westernille Design	L1	1284.50	1291.00	1297.50	nm	-
Center Wavelength Range	L2	1304.50	1311.00	1317.50	nm	-
	L3	1324.50	1331.00	1337.50	nm	-
Extinction Ratio each Lane		3.5	-	-	dB	-
Transmitter and Dispersion Eye ((TDECQ), each Lane	Closure	-	-	3.4	dB	-
Data Rate per Lane		-	53.125	-	GBd/s	
Receiver						
	l LO	1264.50	1271.00	1277.50	nm	-
0 1 11 11 5	L1	1284.50	1291.00	1297.50	nm	-
Center Wavelength Range	L2	1304.50	1311.00	1317.50	nm	-
	L3	1324.50	1331.00	1337.50	nm	-
Damage Threshold, each Lane		4.5	-	-	dBm	-
Average Receive Power each Lane		-7.3	-	3.5	dBm	4
Receive Power (OMA), each Lane		-	-	3.7	dBm	-
Difference in Receive Power between any two Lanes (OMA outer)		-	-	4.1	dB	-
Receiver Sensitivity (OMA outer) each Lane		-	-	-7.3	dBm	-
Stressed Receiver Sensitivity each Lane	(OMA outer)	-4.6	-	-2.6	dBm	5

Notes:

- 1. Average launch power, each lane(min) is informative and not the principal indicator of signal strength. A transmitter with launch power below this value cannot be compliant; however, a value above this does not ensure compliance
- 2. Even if the TDECQ < 1.4dB for an extinction ratio of ≥ 4.5dB or TDECQ < 1.3dB for an extinction ratio of < 4.5dB the minimum OMA outer must exceed the specified minimum value
- 3. Extinction ratio ≥ 4.5dB
- 4. Average receive power, each lane (min) is informative and not the principal indicator of signal strength. A received power below this value cannot be compliant; however, a value above this does not ensure compliance
- 5. Measured with conformance test signal with BER \leq 2.4 x 10^-4

Mechanical specifications



Revision history

Revision	Date	Author	Description
V1.1	13-03-2023	JGN	Initial Document

Note: Nexgen A/S reserves the right to change this document without notice.